

BCR20RM-30LA

Triac

Medium Power Use

REJ03G1725-0100

Rev.1.00

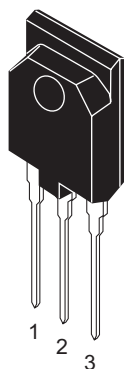
Jul 23, 2008

Features

- $I_{T(RMS)}$: 20 A
- V_{DRM} : 1500 V
- I_{FGTI} , I_{RGTI} , $I_{RGT III}$: 50 mA
- Viso : 2000 V
- Insulated Type
- Planar Passivation Type

Outline

RENESAS Package code: PRSS0003ZA-A
(Package name: TO-3PFM)



1. T₁ Terminal
2. T₂ Terminal
3. Gate Terminal

Applications

Motor and heater

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		30	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	1500	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	1600	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	20	A	Commercial frequency, sine full wave 360° conduction, $T_c = 83^\circ\text{C}$
Surge on-state current	I_{TSM}	200	A	50 Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	200	A^2s	Value corresponding to 1 cycle of half wave 50 Hz, surge on-state current
Peak gate power dissipation	P_{GM}	5	W	
Average gate power dissipation	$P_{G(AV)}$	0.5	W	
Peak gate voltage	V_{GM}	10	V	
Peak gate current	I_{GM}	3	A	
Junction temperature	T_j	- 40 to +125	$^\circ\text{C}$	
Storage temperature	T_{stg}	- 40 to +125	$^\circ\text{C}$	
Mass	—	5.2	g	Typical value
Isolation voltage	V_{iso}	2000	V	$T_a = 25^\circ\text{C}$, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	10	mA	$T_j = 125^\circ\text{C}$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	1.6	V	$T_c = 25^\circ\text{C}$, $I_{TM} = 30\text{ A}$, Instantaneous measurement
Gate trigger voltage ^{Note2}	I	V_{FGTI}	—	—	3.0	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	V_{RGTI}	—	—	3.0	
	III	V_{RGTIII}	—	—	3.0	
Gate trigger current ^{Note2}	I	I_{FGTI}	—	—	50	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	I_{RGTI}	—	—	50	
	III	I_{RGTIII}	—	—	50	
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 125^\circ\text{C}$, $V_D = 1/2 V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	1.6	$^\circ\text{C/W}$	Junction to case ^{Note3}
Critical-rate of rise of off-state commutating voltage ^{Note4}	$(dv/dt)_c$	20	—	—	$\text{V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

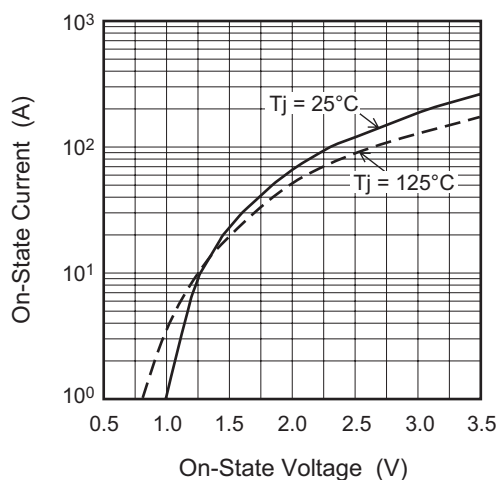
3. The contact thermal resistance $R_{th(j-c)}$ in case of greasing is 0.4°C/W .

4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

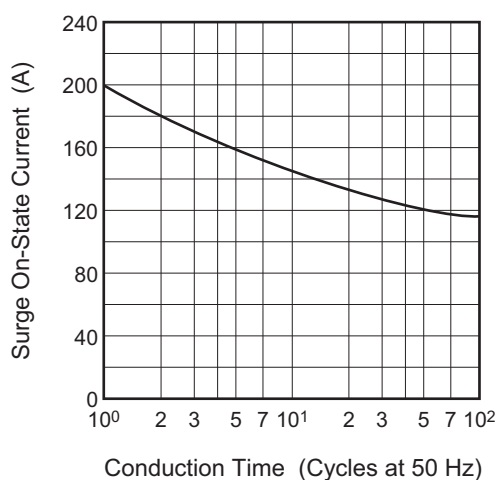
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = -10\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Performance Curves

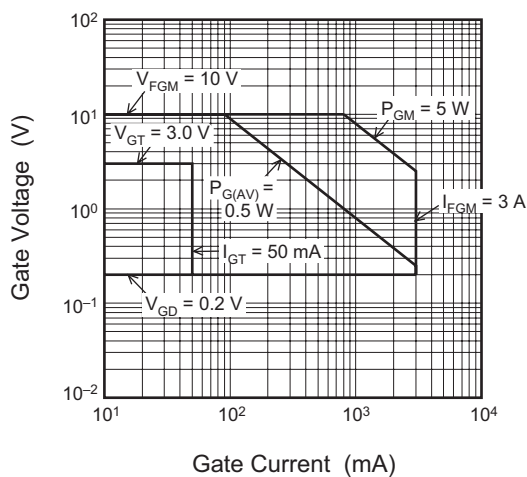
Maximum On-State Characteristics



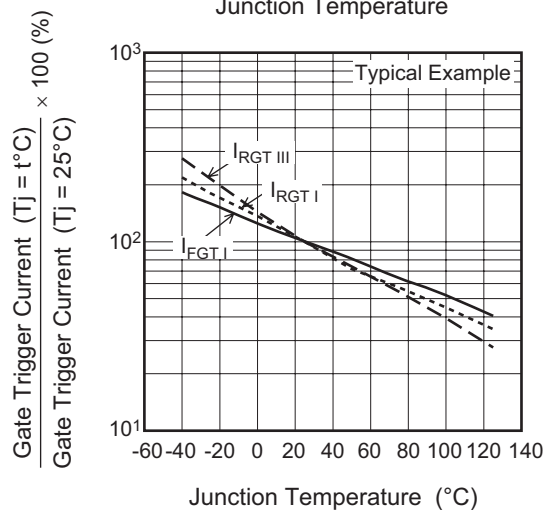
Rated Surge On-State Current



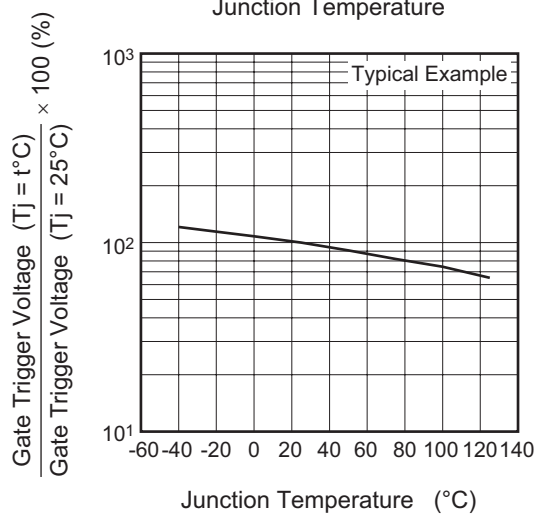
Gate Characteristics (I, II and III)



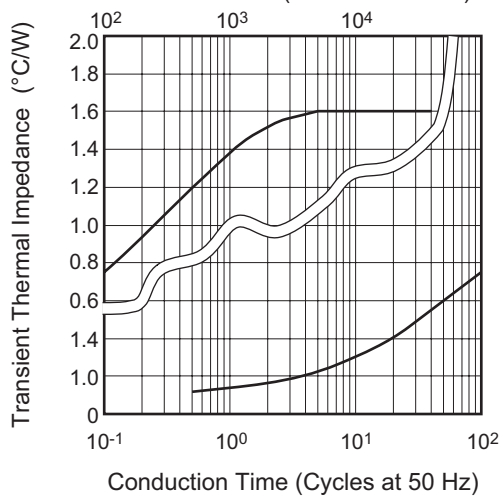
Gate Trigger Current vs. Junction Temperature

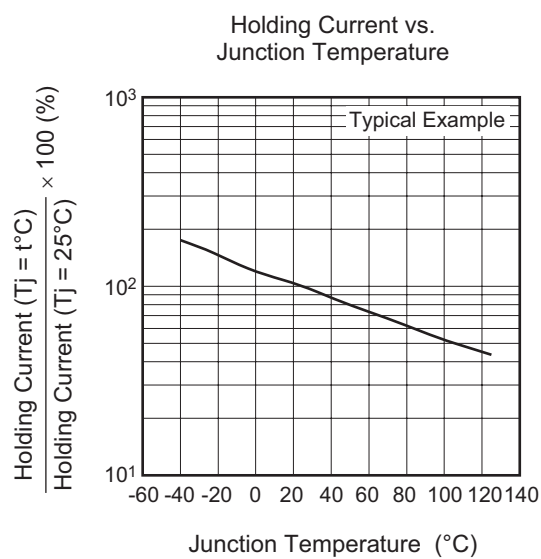
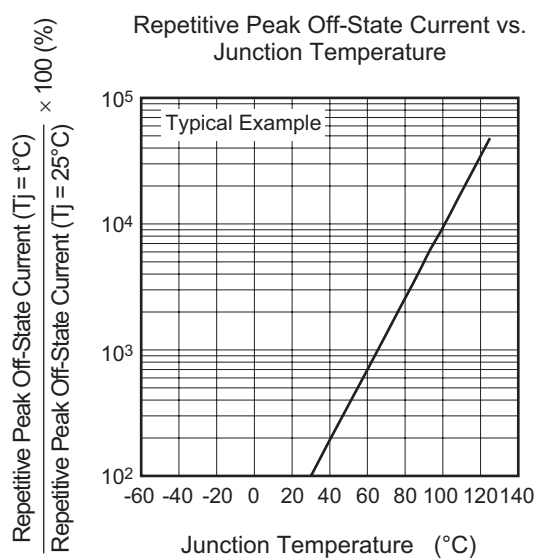
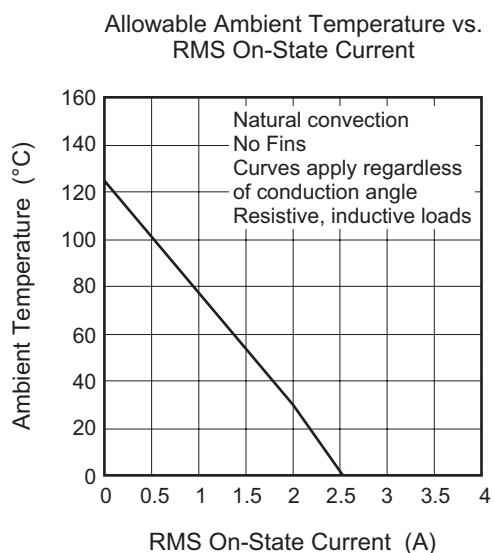
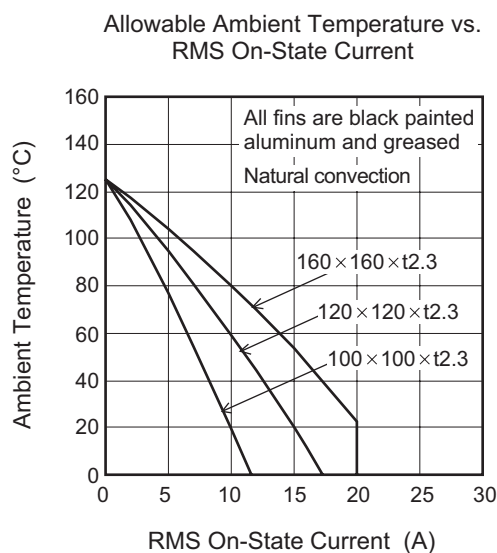
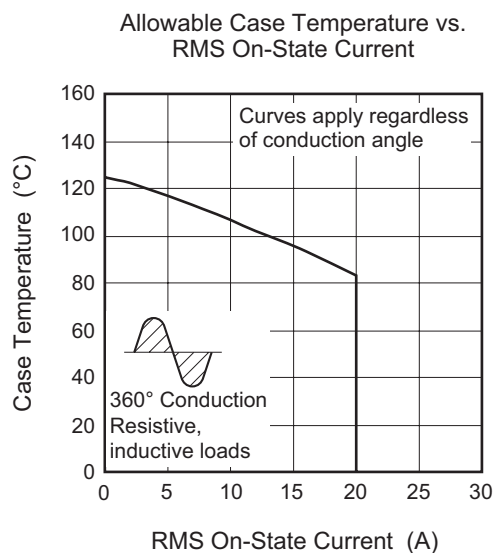
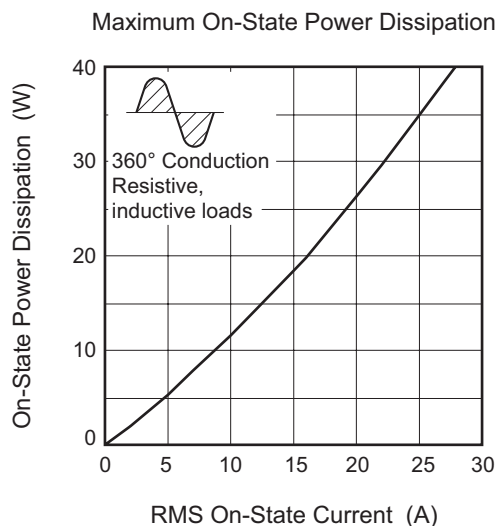


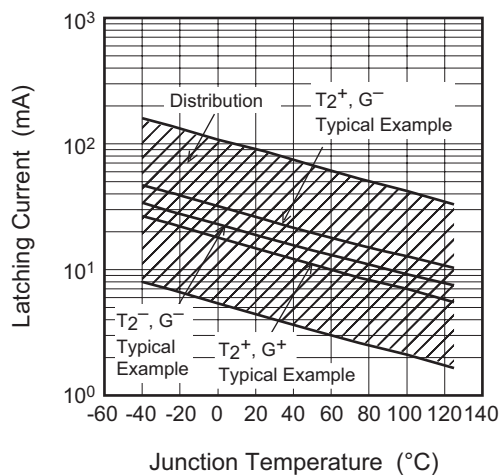
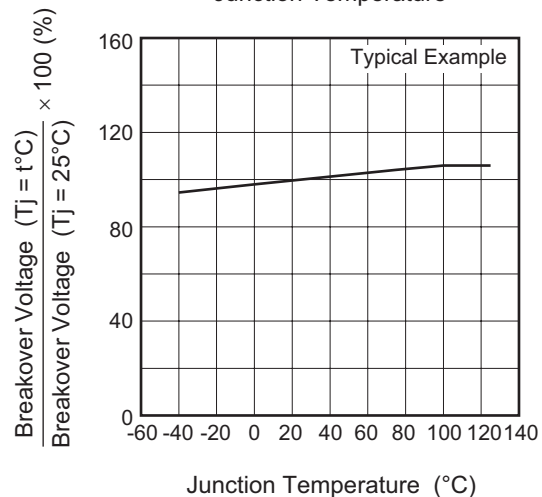
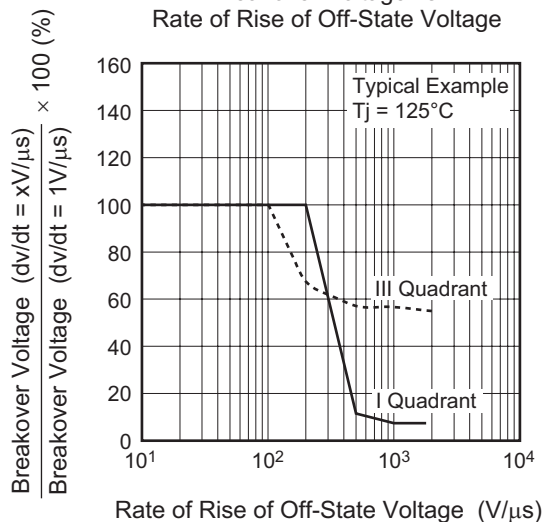
Gate Trigger Voltage vs. Junction Temperature



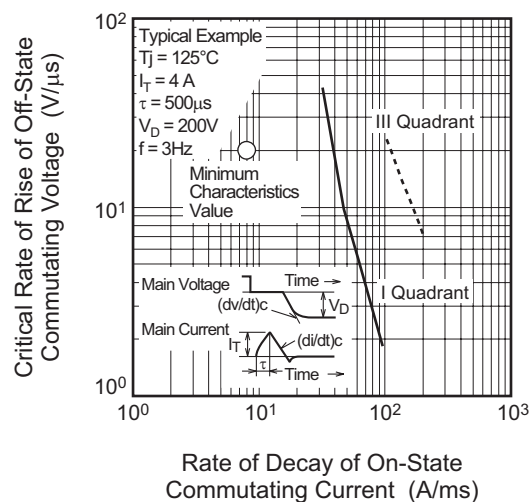
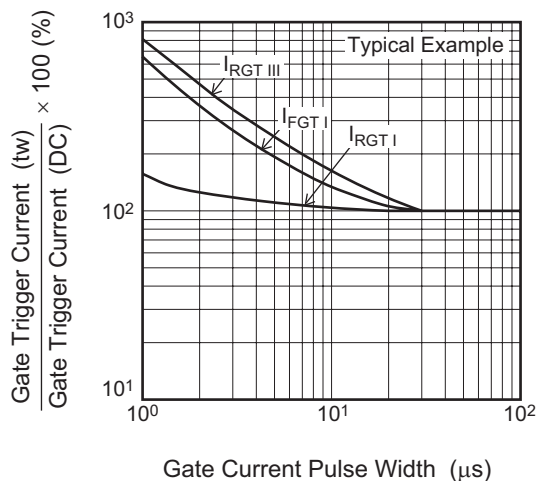
Maximum Transient Thermal Impedance Characteristics (Junction to case)



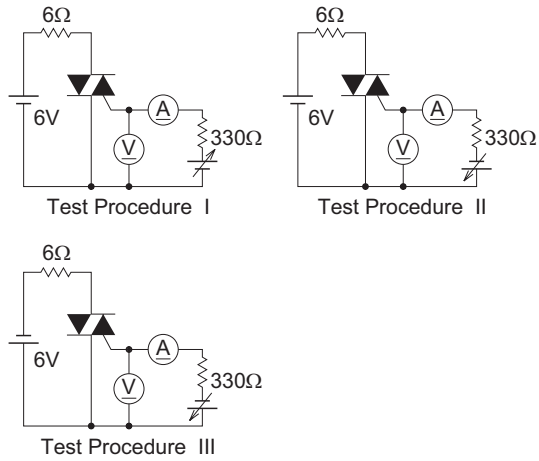


Latching Current vs.
Junction TemperatureBreakover Voltage vs.
Junction TemperatureBreakover Voltage vs.
Rate of Rise of Off-State Voltage

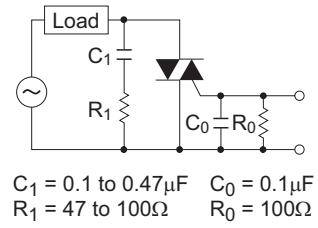
Commutation Characteristics

Gate Trigger Current vs.
Gate Current Pulse Width

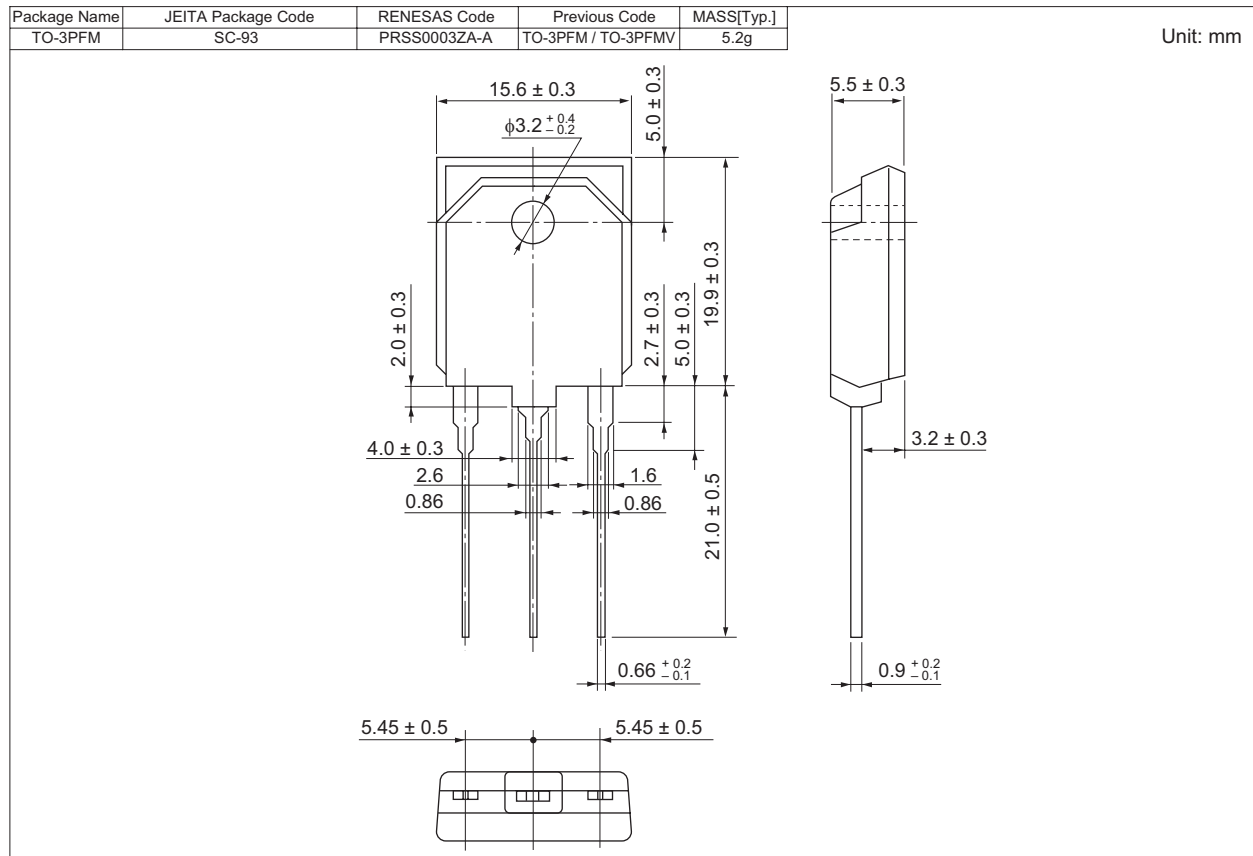
Gate Trigger Characteristics Test Circuits



Recommended Circuit Values Around The Triac



Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Magazine (Tube)	30	Type name	BCR20RM-30LA

Note : Please confirm the specification about the shipping in detail.

Notes:

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